

## PRESS RELEASE

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## The ConFab 2019 Announces Leading Semiconductor Industry Speakers

The ConFab, A Premier Semiconductor Manufacturing Conference for Executives, Announces Keynotes and Influential Industry Speakers in May 2019 Program

*San Francisco, CA* – The ConFab - an exclusive conference and networking event for semiconductor manufacturing and design executives from leading device makers, OEMs, OSATs, fabs, suppliers and fabless/design companies - announces a preliminary list of speakers for the May 14-17 event being held at The Cosmopolitan of Las Vegas.

The ConFab 2019 is excited to welcome these distinguished speakers:

**Jeff Welser**, Vice President and Lab Director, IBM Research - Almaden

**Martin Fink**, Executive Vice President and Chief Technology Officer, Western Digital

**Stephen S. Pawlowski**, Vice President, Advanced Computing Solutions, Micron Technology, Inc.

**Dave Rauch**, Senior Vice President - Worldwide Manufacturing Operations, Western Digital

**John Chen**, Vice President, Technology and Foundry Operations, Nvidia

**Sagar Pushpala**, Vice President, Business Development - Specialty Technologies, TSMC

**Steve Teig**, Chief Technology Officer, Xperi Corp.

**Dan Armbrust**, CEO and co-founder, Silicon Catalyst

**Ren Wu**, Founder and CEO, Novumind

**Alissa Fitzgerald**, Founder and Managing Member, A.M. Fitzgerald & Associates

**Len Jelinek**, Senior Director, Semiconductor Manufacturing, IHS Markit

**Weston Twigg**, Senior Research Analyst and Principal, Pacific Crest

“The hottest areas for semiconductor growth in the coming years are Artificial Intelligence, Quantum Computing, Automotive, Cloud Computing, the IoT, 5G, and virtual reality/augmented reality (VR/AR). The ConFab 2019 program is designed to showcase how these and other applications will challenge the semiconductor industry in new and different ways in the near future. Innovative solutions are going to be required to meet new requirements, and I’m delighted we have so many excellent speakers that can speak to these challenges,” said Pete Singer, Conference Chair of The ConFab and Editor-in-Chief of *Solid State Technology*. More speakers and panelists will be announced in the coming weeks.

The ConFab is a high-level conference for decision-makers and influencers to connect, innovate and collaborate in multiple sessions, one-on-one private business meetings, and other networking activities. For more information, visit [www.theconfab.com](http://www.theconfab.com).

### About The ConFab

The ConFab is the premier semiconductor manufacturing conference and networking event bringing over 200 notable industry leaders together. The ConFab is owned and produced by Extension Media and hosted by Pete Singer, *Solid State Technology*'s Editor-in-Chief, and Conference Chair. To inquire about participating - if you represent an equipment, material or service supplier, contact Kerry Hoffman, Director of Sales, at [khoffman@extensionmedia.com](mailto:khoffman@extensionmedia.com). To inquire about attending, contact Sally Bixby, Sr. Events Director at [sbixby@extensionmedia.com](mailto:sbixby@extensionmedia.com)

## **About Extension Media**

Extension Media is a privately held company operating more than 50 B2B magazines, engineers' guides, newsletters, websites and conferences that focus on high-tech industry platforms and emerging technologies such as: chip design, semiconductor and electronics manufacturing, embedded systems, software, architectures and industry standards. In addition to The ConFab, Extension Media produces other industry-focused events. Those include the Internet of Things Developers Conference (IoT DevCon 2019), the Machine Learning & AI Developers Conference (MLDevCon 2019), and the IoT Device Security Summit. Extension Media publishes: Solid State Technology and Solid-State.com, Embedded Systems Engineering, EECatalog.com, Embedded Intel® Solutions, EmbeddedIntel.com, Chip Design, ChipDesignMag.com.

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